# SPECIFICATION FOR APPROVAL

CUSTOMER	:				
PRODUCT TYPE	:	SMD SEAM SEALING X'TAL 3.2×2.5			
NOMINAL FREQ.	:	25.000625MHz			
TXC P/N	:	7M25000146			
REVISION	:	S1			
CUSTOMER P/N	:				
PM / SALES	:				
DATE	:				
CUSTOMER SIGNATURE & Date					
	_				

- (1) TXC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.
- (2) Orders received and accepted by TXC after return of signed copy of specification will be produced per these specifications.
- (3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.
- (4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

MSL:Level 1
RoHS Compliant



# PRODUCT SPECIFICATION SHEET

PRODUCT TYPE : SMD SEAM SEALING X'TAL 3.2×2.5

NOMINAL FREQ. 25.000625MHz

TXC P/N : 7M25000146

REVISION : S1

PE/RD	QA	MFG
Dobin Huang Robin Huang		
3-Mar-16		

# NOTE:

(1)The green product standard set by TXC is based upon the international standards. Related information is publicly described on the TXC's Website, and updated regularly. The document is compliant with the latest green product quality system directives at the time.

(2)Revision "Sx" is for engineering samples only. PE/RD's approval required.

(3)Revision "Ax" is production ready. PE, QA and MFG's approval required

MSL:Level 1
RoHS Compliant



<u>Rev</u>	Revise page	Revise contents	<u>Date</u>	Ref.No.	<u>Reviser</u>
S1	N/A	Initial released	3-Mar-16	N/A	Xiaoyan Jiang

# **Spec Sheet Contents**

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# **■ ELECTRICAL SPECIFICATIONS**

# Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature :  $25\pm5^{\circ}$ C Relative humidity :  $40\%\sim70\%$ 

If there is any doubt about the results, measurement shall be made within the following limits:

Ambient temperature :  $25\pm3^{\circ}$ C Relative humidity :  $40\%\sim70\%$ 

# Measure equipment

Electrical characteristics measured by S&A250B or equivalent.

# **Crystal cutting type**

The crystal is using AT CUT (thickness shear mode).

# **Unit Weight:**

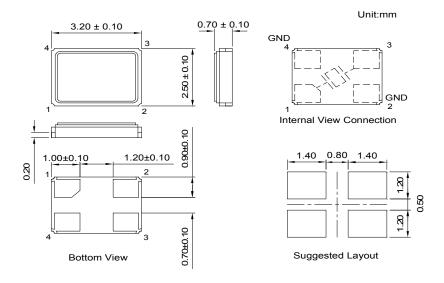
0.018±0.001 g/pcs

	Parameters	Cymbol		Electric	al Spec.		Notes
	Parameters	Symbol	Min.	Тур.	Max.	Units	Notes
1	Nominal Frequency	FL	2	25.00062	5	MHz	-
2	Oscillation Mode	-	Fu	undamen	tal	-	-
3	Load Capacitance	CL		18		pF	-
4	Frequency Tolerance	-	- ±10 ppm a		ppm	at 25 ℃ ± 3 ℃	
5	Frequency Stability	-	±20		ppm	Over Operating Temp. Range (Reference 25℃)	
6	Operating Temperature	-	-40 ~ 85 °C -		-		
7	Aging	-		±3		ppm	1st Year
8	Drive Level	DL	-	10	100	uW	-
9	Effective Resistance Rr	Rr	-	-	50	Ω	-
10	Shunt Capacitance C0	C0	-	-	3	pF -	
11	Insulation Resistance	-	500	-	-	МΩ	at DC 100V
12	Storage Temperature Range	-	-55	~	125	$^{\circ}\!\mathbb{C}$	-

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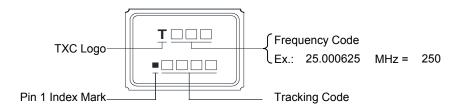
# **■ DIMENSIONS**

(Unit:mm)



\*Coplanarity of solderable areas Camber 0.10 mm Max

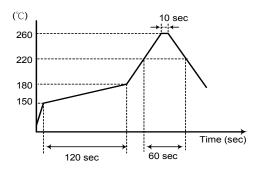
# MARKING



Production Location: Taiwan, China(Ningbo), China(Chungking).

# **■ SUGGESTED REFLOW PROFILE**

Solder melting point :220±10  $^{\circ}$ C , 60 sec. Min. Peak Temperature: 260 ± 5  $^{\circ}$ C , 10 sec. Max.



# **■ SUGGESTED MANUAL SOLDER CONDITION**

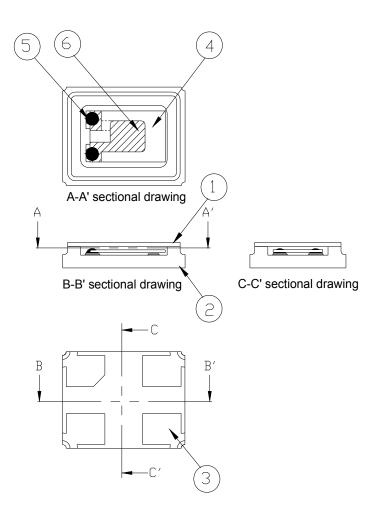
Temperature: 350 ± 10  $^{\circ}$ C

Time: 3 sec.

Re-solder times: twice

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# **■ STRUCTURE ILLUSTRATION**



NO	COMPONENTS	MATERIALS	FINISH/SPECIFICATIONS
1	Lid	Kovar (Fe/Co/Ni)	-
2	Package	Ceramic (Al2O3) + Kovar (Fe/Co/Ni)+ Ag/Cu	-
3	PAD	Au	Tungsten metalize
			+ Ni plating
			+ Au plating
4	Crystal blank	SiO <sub>2</sub>	-
5	Conductive adhesive	Resin+Ag	-
6	Electrode	Noble Metal	-

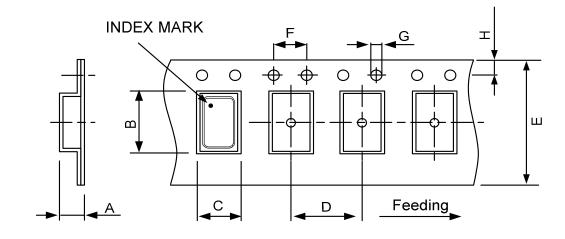
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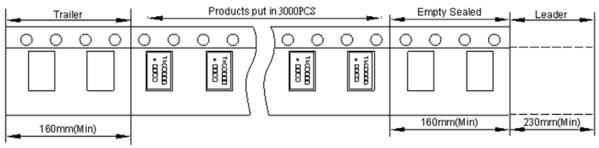
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# **■ EMBOSS CARRIER TAPE & REEL**

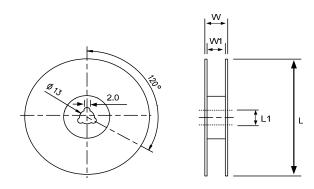


DIMENSIONS	Α	В	С	D	Е	F	G	Н	
DIVIDIONS	1.65±0.10	3.40±0.10	2.70±0.10	4.00±0.10	8.00±0.20	4.00±0.10	1.55±0.10	1.75±0.10	(UNIT: mm)

# REMARK:



User direction of feed



DIMENSIONS	L	L1	W	W1	
DIVILIVOIONS	178±1.00	13±0.50	11.5±0.20	8±0.10	(UNIT: mm)

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#### PACKING

Reel Quantity:

Reel Quantity .

1. Reel X 6 (6 Reels)

2. Reel X 12 (12 Reels)

3. Reel X 25 (12 Reels + 13 Reels)

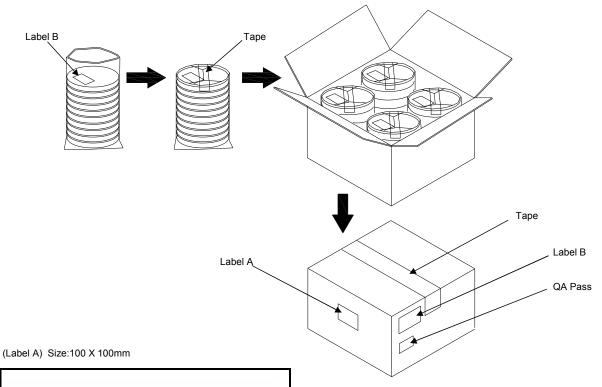
4. Reel X 50 (12 Reelsx2 + 13 Reelsx2)

Box Size:

1. L200 X W200 X H140mm

2. L200 X W200 X H250mm 3. L400 X W200 X H250mm

4. L400 X W400 X H280mm



# TXC

Inv No: 00096815

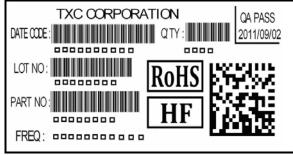
Po No: 21106326- 24- 1

Part No: 000000

Qty: 40000 PCS

C/No: 157- 44

(Lable B) Size:80 X 40mm



# [STORAGE]

- 1.Don't be caught in the rain.
- 2.The storage environment shall be  $5^{\circ}$ C  $\sim$ 40 $^{\circ}$ C temperature and 30%  $\sim$  75%RH humidity and free from the sun shine.
- 3.If customers have special requirements, we can paste labels according to it.

# **■ RELIABILITY SPECIFICATIONS**

# 1.Mechanical Endurance

No.	Test Item	Test Me	Test Methods			
1.1	Drop Test	150 cm height,3 times on concrete flo	150 cm height,3 times on concrete floor .			
1.2	Mechanical Shock	Device are shocked to half sine wave perpendicular axes each 3 times. 0.5	A . C			
1.3	Vibration	Frequency range Amplitude Sweep time Perpendicular axes each test time	A.C			
1.4	Solderability	Temperature Immersing depth Immersion time Flux	245 °C ± 5°C 0.5 mm minimum 5 ± 1 seconds Rosin resin methyl alcohol solvent (1:4)	E		

# 2. Environmental Endurance

No.	Test Item	Test Methods	Test Criteria
2.1	Resistance To Soldering Heat	Pre-heat temperature 125 °C Pre-heat time 60 ~ 120 sec. Test temperature 260 $\pm$ 5 °C Test time 10 $\pm$ 1 sec.	B.C.D
2.2	High Temp. Storage	+ 125 °C ± 3 °C for 500 ± 12 Hrs	B.C.D
2.3	Low Temp. Storage	- 40 °C ± 3 °C for 500 ± 12 Hrs	B.C.D
2.4	Temperature cycle	Total 100 cycles of the following temperature cycle $125 \pm 3^{\circ}C$ $25^{\circ}C$ $-40 \pm 3^{\circ}C$ $10 \text{ min.}$ $2 \text{ min. max.}$	B.C.D
2.5	High Temp&Humidity	85°C ± 3°C , RH 85% , 500 Hrs	B.C.D

# **RELIABILITY SPECIFICATIONS**

	Specifications					
Α	Frequency change: Within ±5ppm or in customer's specification.					
В	Frequency change: Within ±10ppm or in customer's specification.					
С	Equivalent series resistance(E.S.R) change: Within ±15% or 10Ω(larger value).					
D	After conditioning, quartz crystal units shall be subjected to standard atmospheric conditions for 2 hour, and measured.					
Е	Minimum 95% of immersed terminal shall be covered with new uniform solder.					

# **Measurement condition**

Electrical characteristics measured by S&A250B or equivalent.